

**REMARKS****Summary of the Office Action**

Claims 27-30 are pending.

Claim 27 stands rejected under 35 U.S.C. § 102(b) as being anticipated by U.S. Patent No. 5,742,481 to Murphy et al. (Murphy '481).

Claims 28-29 stand rejected under 35 U.S.C. § 103(a) as being unpatentable over Murphy '481 in view of U.S. Patent No. 5,877,554 to Murphy (Murphy '554).

Claim 30 is objected to as being dependent on a rejected base claim, but would be allowable if rewritten in independent form. Applicants appreciate the indication that claim 30 contains allowable subject matter.

**Claims 27-29 Are Allowable Over the Prior Art**

Applicants traverse the rejection of claims 27-29. Contrary to the Examiner's assertion, Murphy '481 fails to teach or suggest, among other things, "molding a package base including a plurality of side walls and a floor having a plurality of holes formed therethrough ... wherein said molding includes molding an electrically conductive frame into the floor ...."

The Examiner refers to the guide member 214 and guide wall member 224 in Figs. 1 and 7-9 of Murphy '481. However, Murphy '481 does not disclose "molding" the guide member 214 or the guide wall member 224. Moreover, Murphy '481 fails to disclose "molding an electrically conductive frame into the floor, said frame having a plurality of holes formed therein and the holes through the floor register with the holes of said frame," as recited in independent claim 27. As plainly shown in Figs. 7-9, there is no "electrically conductive frame [molded] into the floor" as recited in independent claim

27. Contrary to the Examiner's allegations, socket terminals 206 are not molded into guide member 214. For example, Fig. 7-9 shows the guide member 214 spaced apart from the socket terminals 206. Thus, Murphy '481 fails to teach or suggest each of the limitations of independent claim 27. For at least this reason, the rejection of claim 27 under Section 102(b) should be withdrawn.

The Examiner's comments to the effect that steps of claim 27 would be inherently satisfied by the apparatus of Murphy '481 are not understood. Murphy '481 does not disclose molding guide member 214 or molding socket terminals 206 into guide member 214. Therefore, it is clear that Murphy '481 does not anticipate claim 27.

With respect to the rejection under Section 103, claims 28 and 29 incorporate each of the limitations of independent claim 27. Murphy '554 fails to disclose "molding a package base including a plurality of side walls and a floor having a plurality of holes formed therethrough ... wherein said molding includes molding an electrically conductive frame into the floor." Accordingly, neither Murphy '481 nor Murphy '554 teach or suggest each of the limitations of independent claim 27 and, for at least this reason, the rejection of claims 28 and 29 should be withdrawn.

### **Conclusion**


Claims 27-30 are pending in the present application. In view of the foregoing amendments and remarks, Applicants respectfully request reconsideration and the timely allowance of claims 27-30. Should the Examiner feel that there are any issues outstanding after consideration of this response, the Examiner is invited to contact Applicants' undersigned representative at 202.739.5271 to expedite prosecution.

**EXCEPT** for issue fees payable under 37 C.F.R. § 1.18, the Commissioner is hereby authorized by this paper to charge any additional fees during the entire pendency of this application including fees due under 37 C.F.R. §§ 1.16 and 1.17 which may be required, including any required extension of time fees, or credit any overpayment to Deposit Account 50-0310. This paragraph is intended to be a **CONSTRUCTIVE PETITION FOR EXTENSION OF TIME** in accordance with 37 C.F.R. §1.136(a)(3).

Respectfully submitted,

**MORGAN, LEWIS & BOCKIUS LLP**

By:

  
John D. Zele  
Reg. No. 39,887

Dated: November 17, 2005

**CUSTOMER NO. 009629**  
**MORGAN, LEWIS & BOCKIUS LLP**  
1111 Pennsylvania Avenue, N.W.  
Washington, D.C. 20004  
Phone: 202.739.3000  
Facsimile: 202.739.3001